

350mA, 40V Schottky Barrier Diode

FEATURES

- Low forward voltage drop
- Surface mount device type
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Adapters
- For switching power supply
- Inverter

MECHANICAL DATA

- Case: SOD-523F
- Molding compound meets UL 94 V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- · Polarity: Indicated by cathode band
- Weight: 1.60mg (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	350	mA	
V _{RRM}	40	V	
V_F at I_F = 200mA	0.6	V	
T _{J MAX}	125	°C	
Package	SOD-523F		
Configuration	Single die		









ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	SD103AXM5	UNIT
Marking code on the device		S4	
Power dissipation	PD	200	mW
Repetitive peak reverse voltage	V _{RRM}	40	V
DC blocking reverse voltage	V _R	40	V
Forward current	I _F	350	mA
Non-repetitive peak forward surge current @ t = 8.3ms single half sine wave	I _{FSM}	2	A
Junction temperature range	TJ	-55 to +125	°C
Storage temperature range	T _{STG}	-55 to +150	°C



THERMAL PERFORMANCE

PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-ambient thermal resistance	R _{eja}	158	°C/W

Note: Units mounted on PCB (10mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 20 \text{mA}, T_J = 25^{\circ}\text{C}$		-	0.32	0.37	V
Forward voltage	$I_F = 200 \text{mA}, T_J = 25^{\circ}\text{C}$	V _F	-	0.48	0.60	V
Reverse voltage ⁽²⁾	$I_R = 100 \mu A, T_J = 25^{\circ}C$	V _R	40	-	-	V
Reverse current ⁽²⁾	$V_{R} = 30V, T_{J} = 25^{\circ}C$	I _R	-	-	5	μA
Junction capacitance	$f = 1MHz, V_R = 0V$	CJ	-	23	50	pF
Reverse recovery time	$I_{\rm F} = I_{\rm R} = 50 {\rm mA}, R_{\rm L} = 100 {\Omega}$	t _{rr}	-	-	4	ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
SD103AXM5 RSG	SOD-523F	8K / 7" Reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$



Fig.1 Typical Forward Characteristics

Fig.3 Typical Junction Capacitance





Fig.2 Typical Reverse Characteristics

Fig.4 Power Derating Curve





PACKAGE OUTLINE DIMENSION



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.50	0.77	0.020	0.030
b	0.25	0.40	0.010	0.016
с	0.07	0.20	0.003	0.008
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
н	1.50	1.70	0.059	0.067



SUGGEST PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	0.80	0.031
В	0.60	0.024
С	2.30	0.091



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